

# Single N-channel MOSFET

## ELM16402EA-S

### ■General description

ELM16402EA-S uses advanced trench technology to provide excellent  $R_{ds(on)}$ , low gate charge and low gate resistance.

### ■Features

- $V_{ds}=30V$
- $I_d=6.9A$  ( $V_{gs}=10V$ )
- $R_{ds(on)} < 28m\Omega$  ( $V_{gs}=10V$ )
- $R_{ds(on)} < 42m\Omega$  ( $V_{gs}=4.5V$ )

### ■Maximum absolute ratings

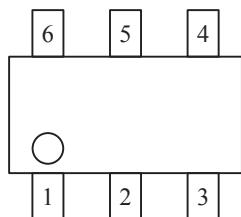
Parameter	Symbol	Limit	Unit	Note
Drain-source voltage	$V_{ds}$	30	V	
Gate-source voltage	$V_{gs}$	$\pm 20$	V	
Continuous drain current Ta=25°C	$I_d$	6.9	A	1
Ta=70°C		5.8		
Pulsed drain current	$I_{dm}$	20	A	2
Power dissipation Ta=25°C	$P_d$	2.00	W	
Ta=70°C		1.44		
Junction and storage temperature range	$T_j, T_{stg}$	-55 to 150	°C	

### ■Thermal characteristics

Parameter		Symbol	Typ.	Max.	Unit	Note
Maximum junction-to-ambient	$t \leq 10s$	$R_{\theta ja}$	48.0	62.5	°C/W	1
Maximum junction-to-ambient	Steady-state		74.0	110.0	°C/W	
Maximum junction-to-lead	Steady-state	$R_{\theta jl}$	35.0	40.0	°C/W	3

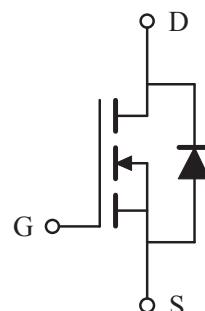
### ■Pin configuration

SOT-26(TOP VIEW)



Pin No.	Pin name
1	DRAIN
2	DRAIN
3	GATE
4	SOURCE
5	DRAIN
6	DRAIN

### ■Circuit



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### ■Electrical characteristics

$T_a=25^\circ C$

Parameter	Symbol	Condition		Min.	Typ.	Max.	Unit
<b>STATIC PARAMETERS</b>							
Drain-source breakdown voltage	$BV_{DSS}$	$I_d=250\mu A, V_{GS}=0V$		30			V
Zero gate voltage drain current	$I_{DSS}$	$V_{DS}=24V, V_{GS}=0V$			1		$\mu A$
			$T_j=55^\circ C$			5	
Gate-body leakage current	$I_{GSS}$	$V_{DS}=0V, V_{GS}=\pm 20V$				100	nA
Gate threshold voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_d=250\mu A$		1.0	1.9	3.0	V
On state drain current	$I_{D(on)}$	$V_{GS}=4.5V, V_{DS}=5V$		20			A
Static drain-source on-resistance	$R_{DS(on)}$	$V_{GS}=10V, I_d=6.9A$			22.5	28.0	$m\Omega$
			$T_j=125^\circ C$		31.3	38.0	
		$V_{GS}=4.5V, I_d=5.0A$			34.5	42.0	$m\Omega$
Forward transconductance	$G_{FS}$	$V_{DS}=5V, I_d=6.9A$		10.0	15.4		S
Diode forward voltage	$V_{SD}$	$I_S=1A$			0.76	1.00	V
Max. body-diode continuous current	$I_S$					3	A
<b>DYNAMIC PARAMETERS</b>							
Input capacitance	$C_{iss}$	$V_{GS}=0V, V_{DS}=15V, f=1MHz$			680	820	pF
Output capacitance	$C_{oss}$				102		pF
Reverse transfer capacitance	$C_{rss}$				77		pF
Gate resistance	$R_g$	$V_{GS}=0V, V_{DS}=0V, f=1MHz$			3.0	3.6	$\Omega$
<b>SWITCHING PARAMETERS</b>							
Total gate charge (10V)	$Q_g$	$V_{GS}=10V, V_{DS}=15V, I_d=6.9A$			13.84	16.70	nC
Total gate charge (4.5V)	$Q_g$				6.74	8.10	nC
Gate-source charge	$Q_{gs}$				1.82		nC
Gate-drain charge	$Q_{gd}$				3.20		nC
Turn-on delay time	$t_{d(on)}$	$V_{GS}=10V, V_{DS}=15V$			4.6		ns
Turn-on rise time	$t_r$				4.1		ns
Turn-off delay time	$t_{d(off)}$		$R_L=2.2\Omega, R_{gen}=3\Omega$		20.6		ns
Turn-off fall time	$t_f$				5.2		ns
Body diode reverse recovery time	$t_{rr}$		$I_F=6.9A, dI/dt=100A/\mu s$		16.5	20.0	ns
Body diode reverse recovery charge	$Q_{rr}$	$I_F=6.9A, dI/dt=100A/\mu s$			7.8		nC

### NOTE :

1. The value of  $R_{\theta ja}$  is measured with the device mounted on 1in<sup>2</sup> FR-4 board of 2oz. Copper, in still air environment with  $T_a=25^\circ C$ . The value in any given applications depends on the user's specific board design. The current rating is based on the  $t \leq 10s$  thermal resistance rating.
2. Repetitive rating, pulse width limited by junction temperature.
3. The  $R_{\theta ja}$  is the sum of the thermal impedance from junction to lead  $R_{\theta jl}$  and lead to ambient.
4. The static characteristics in Figures 1 to 6 are obtained using 80 $\mu s$  pulses, duty cycle 0.5%max.
5. These tests are performed with the device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_a=25^\circ C$ . The SOA curve provides a single pulse rating.



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## ■ Typical electrical and thermal characteristics

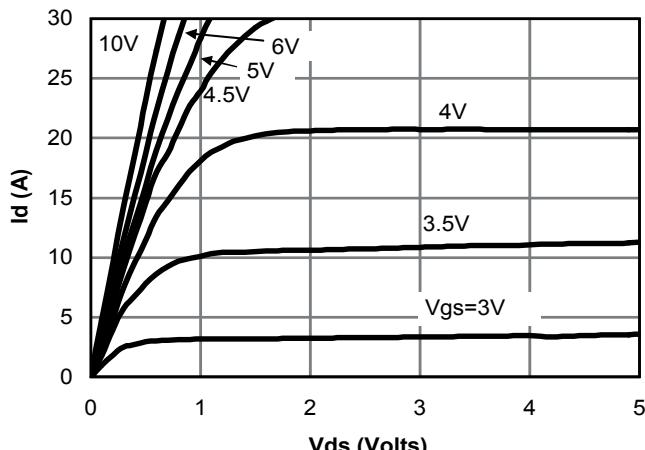


Fig 1: On-Region Characteristics

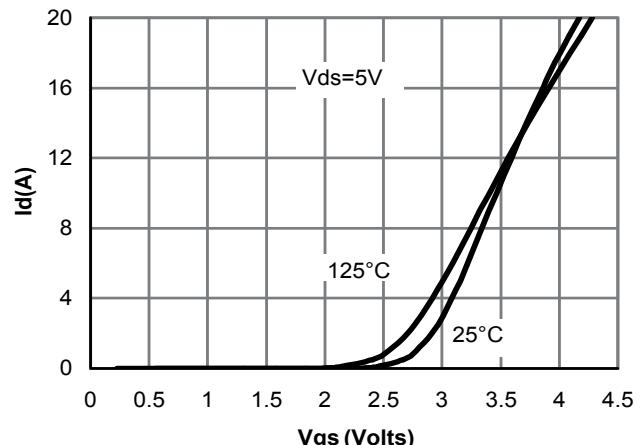


Figure 2: Transfer Characteristics

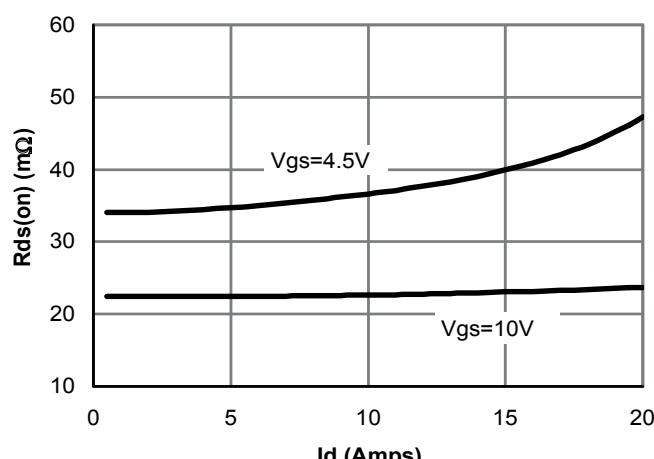


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

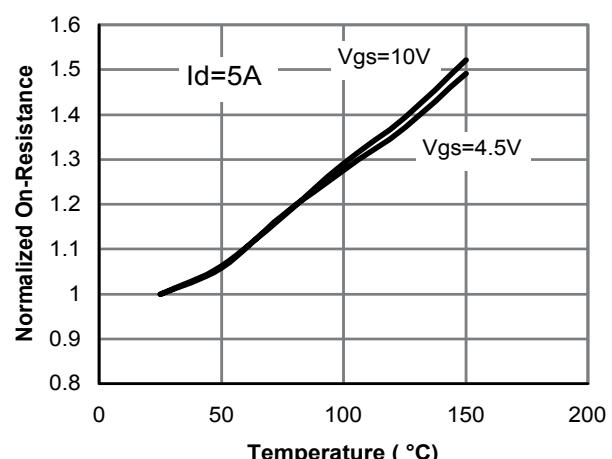


Figure 4: On-Resistance vs. Junction Temperature

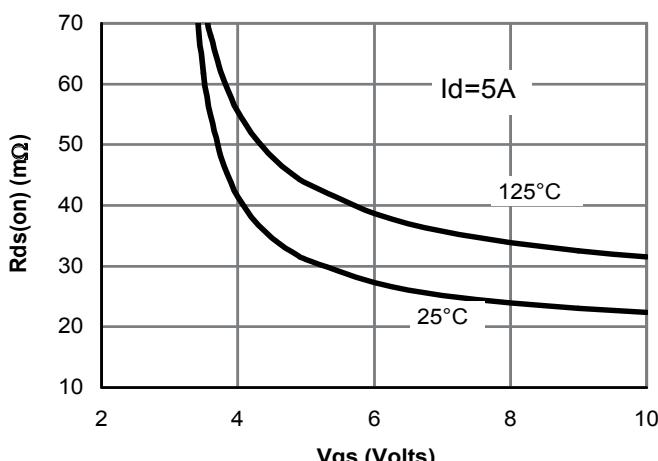


Figure 5: On-Resistance vs. Gate-Source Voltage

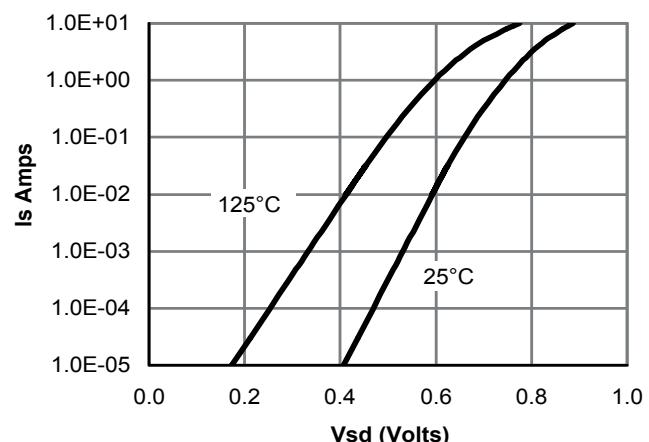


Figure 6: Body diode characteristics

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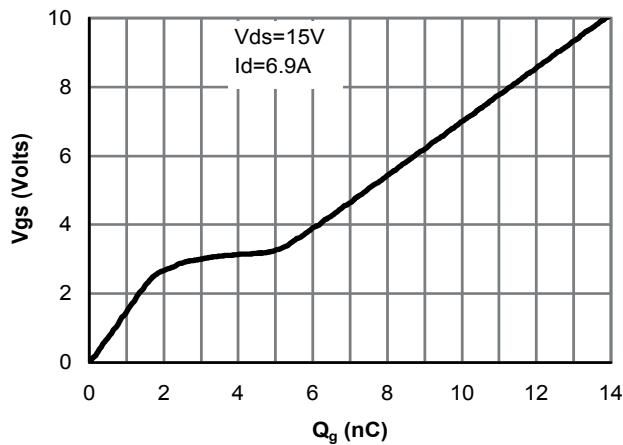


Figure 7: Gate-Charge characteristics

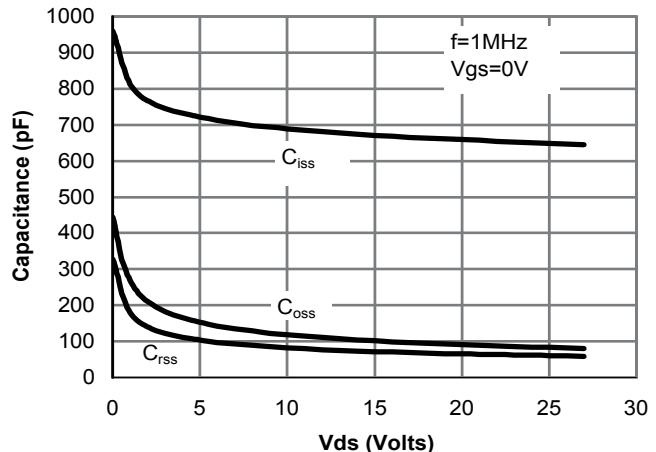


Figure 8: Capacitance Characteristics

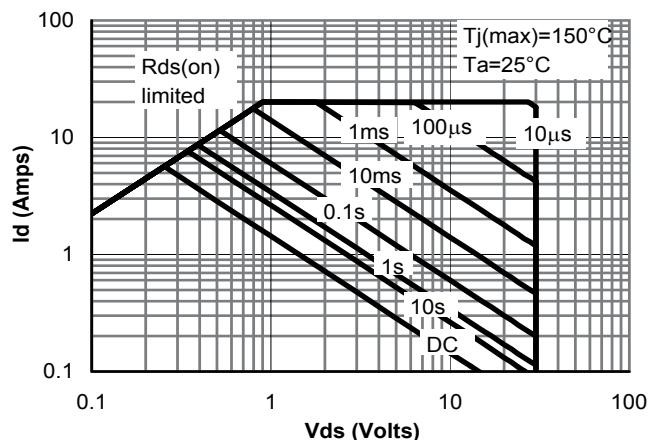


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

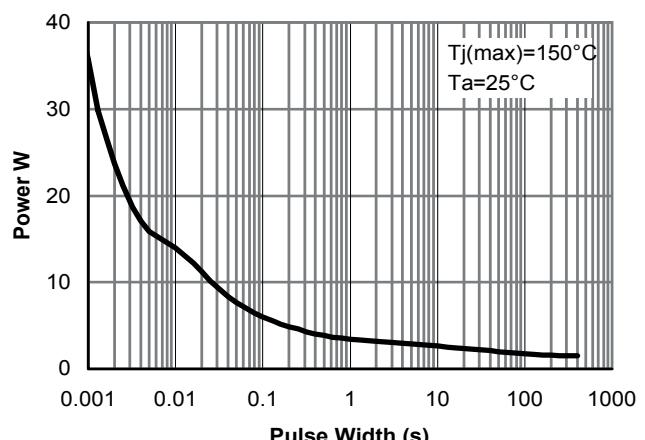


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note E)

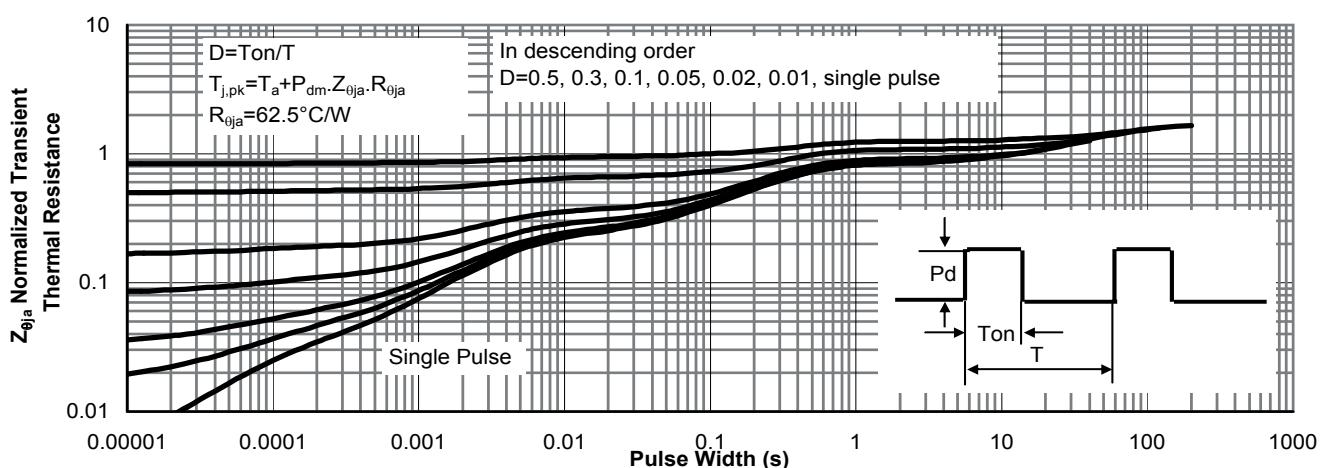


Figure 11: Normalized Maximum Transient Thermal Impedance